

**AMENDMENTS TO THE CLAIMS**

**Listing of claims:**

This listing of claims replaces all prior versions and listings of claims in the application.

1. (Currently Amended) A method of manufacturing a flexible laminate substrate including a metal foil bonded onto at least one surface of a heat-resistant adhesive film, the method comprising the steps of:

thermally laminating the heat-resistant adhesive film and the metal foil between one or more pairs of metal rolls via a protective film to fabricate a laminate in which the heat-resistant adhesive film, the metal foil, and the protective film are bonded together, a first tension in a machine direction of the laminate being applied after the laminate has passed between the metal rolls; and

delaminating the protective film, a second tension in the machine direction being applied to the laminate during delamination;

wherein said second tension is greater than said first tension,

the first tension and the second tension being regulated using nip rolls, and

a ratio of the second tension to the first tension ranges from 1.2 to 10.

2. (Original) The method of claim 1, wherein the tension on the laminate during the delamination of the protective film is from 50 N/m to 500 N/m inclusive.

3. (Previously Presented) The method of claim 1, wherein the tension on the laminate after the passage between the metal rolls is from 10 N/m to 200 N/m inclusive.

4. (Cancelled)

5. (Previously Presented) The method of claim 1, wherein during the delamination of the protective film, the laminate has a temperature less than or equal to a glass transition temperature of an adhesive layer in the heat-resistant adhesive film.

6. (Previously Presented) The method of claim 1, wherein the protective film is non-thermoplastic.